

SPECIFICATION SHEET

SPECIFICATION SHEET NO.	R0610- D882S8000SD882		
DATE	June 10, 2024		
REVISION	A2 Updated With Most Recent Data		
DESCRIPTION AND	SMD Plastic-Encapsulate Transistors, 3 Pads, Case SOT-89-3L S8 Series, Transistor Type NPN		
MAIN PARAMETRICS	hfe Rank Range 60~400		
	Collector-Base Voltage 40V Max. Collector Current 3A Max.		
	Operating Temp. Range -55°C ~+150°C		
	Package in Tape/Reel, 1000pcs/Reel		
	RoHS III/REACH Compliant and Halogen Free (HF)		
CUSTOMER			
CUSTOMER PART NO.			
CROSS REF. PART NO.			
ORIGINAL MFG/PART NO.	MDD Diodes/D882		
PART CODE	D882S8000SD882		

VENDOR APPROVE

Issued/Checked/Approved







DATE: June 10, 2024

CUSTOMER APPROVE	
DATE:	



SMD TRANSISTORS D8 SERIES CASE SOT-89-3L

MAIN FEATURE

- Epoxy Meets UL-94 V-0 Flammability Rating
- High Collector Current: IC=3A
- · Large Power Dissipation
- Complementary PNP Type Available (Part Code B772S8000SB772)
- Surface Mount Package Ideally Suited for Automatic Insertion
- REACH/RoHS III Complaint and Halogen Free
- Cross Main Competitor Parts in Market



APPLICATION

For SMD application

ELECTRICAL CHARACTERISTICS

- See Page 4~ Page 5
- HOW TO ORDER
- Please Follow Up Part Code Guide And Indicate Pat Code When You Order Or RFQ For Custom Specification.

PART CODE GUIDE



CODE	NAME	KEY SPECIFICATION OPTION
D8	Product Series Code	SMD Plastic-Encapsulate Transistors D8 series
82	Specification Code	For Original Part Number D882
S8	Case Code	S8: Case SOT-89-3L
000S	Internal Control Code	Custom letter A~Z, a-z or Digits (0-9)
D882	Marking Code	Custom letter A~Z, a-z or Digits (0-9)



SMD TRANSISTORS D8 SERIES CASE SOT-89-3L

DIMENSION (Unit: Inch/mm)

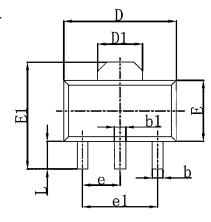
Image for reference

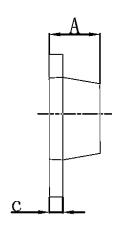


Marking:

D882

SOT-89-3L

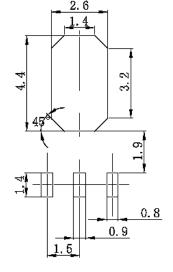




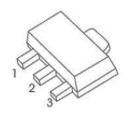
Symbol	Value (mm)		
	Min.	Тур.	Max.
Α	1.4		1.6
b	0.32		0.52
b1	0.40		0.58
С	0.35		0.44
D	4.4		4.6
E	2.3		2.60
E1	3.94		4.25
е		1.5	
e1		3.0	
L	0.90		1.20

Recommend Pad Layout

Tolerance: ±0.05mm



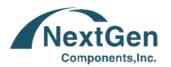
Pin Function



- 1. Base
- 2. Emitter
- 3. Collector

6/10/2024

3



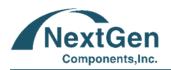
SMD TRANSISTORS D8 SERIES CASE SOT-89-3L

CLASSIFICATION OF hFE

PART CODE	RANK CODE	RANK RANG	MARKING
D882S8000SD882	R	60~120	D882
	0	100~200	
	Y	160~320	
	GR	200~400	

MAXIMUM RATINGS - @ 25 °C

PARAMETER	SYMBOLS	VALUE	UNITS
Collector-Base Voltage	Vсво	40	Volts
Collector-Emitter Voltage	VCEO	30	Volts
Emitter-Base Voltage	VEBO	6	Volts
Collector Current -Continuous	Ic	3	А
Collector Power Dissipation	Pc	0.5	W
Thermal Resistance From Junction To Ambient	Roja	250	°C/W
Junction Temperature	TJ	+150	°C
Storage Temperature Range	Тѕтс	-55 ~ +150	°C



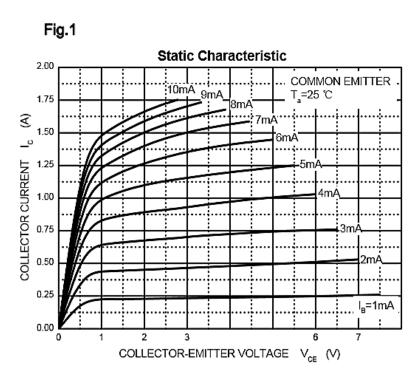
SMD TRANSISTORS D8 SERIES CASE SOT-89-3L

ELECTRICAL CHARACTERISTICS- @ 25 °C

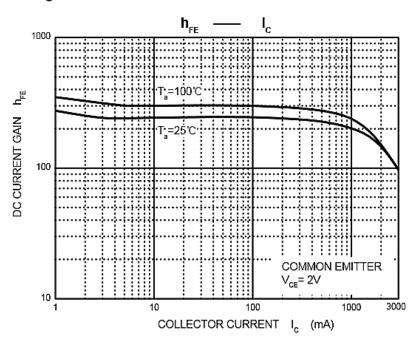
PARAMETER	SYMBOLS	VALUE		UNIT	TEST CONDITION	
		MIN.	TYP.	MAX.		
Collector-base Breakdown Voltage	V(BR)CBO	40			V	Ic= 100μA, IE=0
Collector-emitter Breakdown Voltage	V(BR)CEO	30			V	Ic= 10mA, IB=0
Emitter-base Breakdown Voltage	V(BR)EBO	6			V	IE= 100μA, IC=0
Collector Base Cut-off Current	Ісво			1	μА	VCB= 40V, IE=0
Collector Emitter Cut-off Current	ICEO			10	μΑ	VCE= 30V, IB=0
Emitter Base Cut-off Current	ІЕВО			1	μΑ	VEB= 6V, IC=0
DC Current Gain	hFE(1)	30	150			VCE=2V, IB=0.2A
	hFE(2)	60	160	400		VCE=2V, IC=1A
Collector-emitter Saturation Voltage	VCE(sat)		0.3	0.5	V	IC=2A, IB=0.2A
Base-emitter Saturation Voltage	VBE(sat)		1.0	1.5	V	Ic=2A, IB=0.2A
Transition Frequency	fτ	50			MHz	VCE=5V, IC= 0.1A, f=10MHz
Collector Output Capacitance	Cob		45		pF	VCB=10V, IE=0, f=1MHz

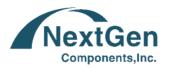


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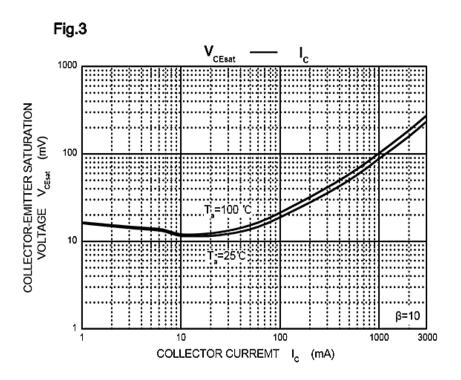
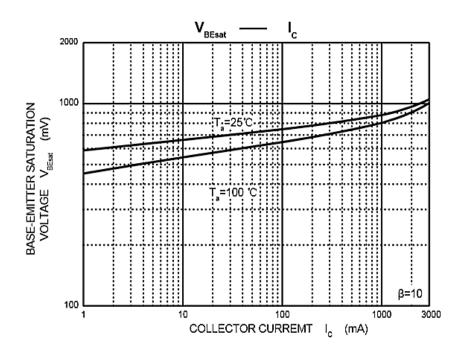
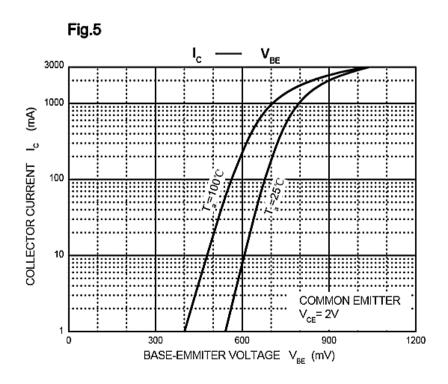
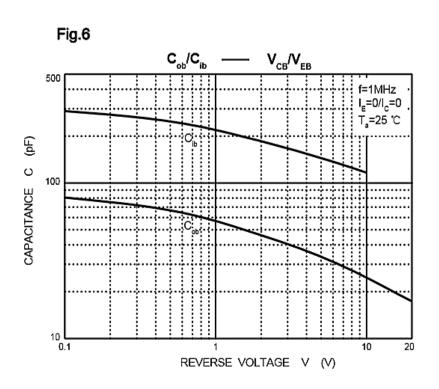


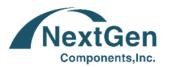
Fig.4



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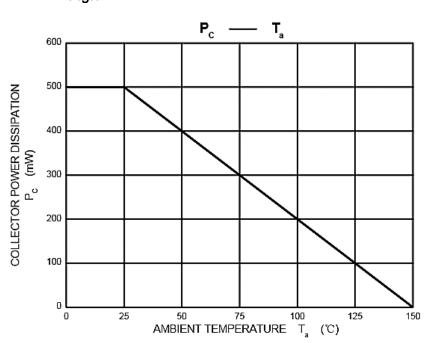






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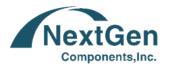




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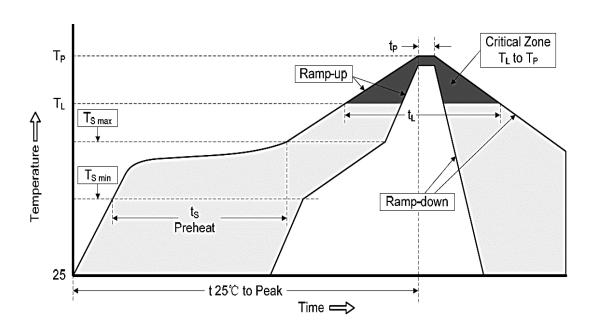
RELIABILITY

Number	Experiment Items	Experiment Method And Conditions	Reference Documents
1	Solder Resistance Test	Test 260°C± 5°C for 10 ± 2 sec. Immerse body into solder 1/16" ± 1/32"	MIL-STD-750D METHOD-2031.2
2	Solderability Test	230°C ±5°C for 5 sec.	MIL-STD-750D METHOD-2026.1 0
3	Pull Test	1 kg in axial lead direction for 10 sec.	MIL-STD-750D METHOD-2036.4
4	Bend Test	0.5Kg Weight Applied To Each Lead, Bending Arcs 90 °C ± 5 °C For 3 Times	MIL-STD-750D METHOD-2036.4
5	High Temperature Reverse Bias Test	TA=100°C for 1000 Hours at VR=80% Rated VR	MIL-STD-750D METHOD-1038.4
6	Forward Operation Life Test	TA=25°C Rated Average Rectified Current	MIL-STD-750D METHOD-1027.3
7	Intermittent Operation Life Test	On state: 5 min with rated IRMS Power Off state: 5 min with Cool Forced Air. On and off for 1000 cycles.	MIL-STD-750D METHOD-1036.3
8	Pressure Cooker Test	15 PSIG, Ta=121°C, 4 hours	MIL-S-19500 APPENOIXC
9	Temperature Cycling Test	-55°C~+125°C; 30 Minutes For Dwelled Time 5 minutes for transferred time. Total: 10 cycles.	MIL-STD-750D METHOD-1051.7
10	Thermal Shock Test	0°C for 5 minutes., 100°C for 5minutes, Total: 10 cycles	MIL-STD-750D METHOD-1056.7
11	Forward Surge Test	8.3ms Single Sale Sine-wave One Surge.	MIL-STD-750D METHOD-4066.4
12	Humidity Test	Ta=65°C, RH=98% for 1000 hours.	MIL-STD-750D METHOD-1021.3
13	High Temperature Storage life Test	150°C for 1000 Hours	MIL-STD-750D METHOD-1031.5

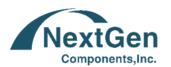


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SUGGESTED REFLOW PROFILE - For Reference Only



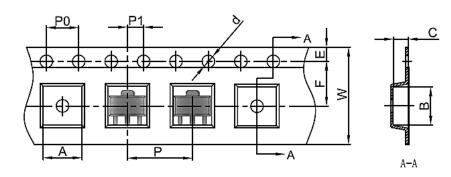
PROFILE FEATURE		PB-FREE ASSEMBLY
Average Ramp-up Rate (Ts Max to Tp)		3°C/second Max
Preheat	Temperature Min (Ts Min.)	150°C
	Temperature Max (Ts Max.)	200°C
	Time (ts Min. to ts Max.)	60 ~ 180 seconds
Time maintained above	Temperature (TL)	217°C
	Time (tL)	60 ~ 150 seconds
Peak/Classification Temperature (Tp)		260 °C
Time within 5°C of actual Peak Temperature (tp)		20 ~ 40 seconds
Ramp-down rate		6 °C /Second Max.
Time 25 °C to Peak Temperature		8 minutes Max.
Suggest reflow times		3 Times Max.

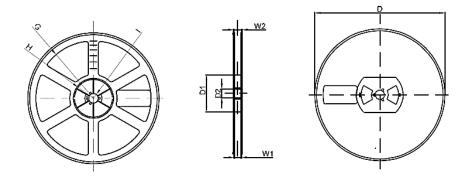


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TAPE/REEL - Unit: mm

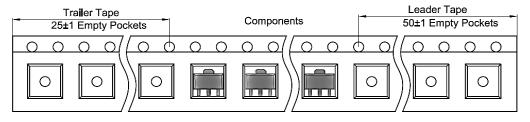
All Devices are packed in accordance with EIA standard RS-481-A and specifications. SOT-89-3L parts are shipped in tape. The carrier tape is made from a dissipative (carbon filled) polycarbonate resin. The cover tape is a multilayer film (Heat Activated Adhesive in nature) primarily composed of polyester film, adhesive layer, sealant, and antistatic sprayed agent. These reeled parts In standard option are shipped with 1,000 units per 7" or 18cm diameter reel. The reels are clear in color and is made of polystyrene plastic (anti-static coated).





Symbol	Dimension (mm)
Α	4.85±0.1
В	4.45±0.1
С	1.85±0.1
d	φ1.50±0.1
E	1.75±0.1
F	5.50±0.1
P 0	4.00±0.1
Р	8.00±0.1
P 1	2.00±0.1
W	12.00±0.1
D	ф178±2
D1	54.4±1
D2	13.0±1
G	R78±1
Н	R25.6±1
I	R6.5±1
W 1	13.20±1
W2	16.50±1

TAPE LEADER AND TRAILER





SMD TRANSISTORS D8 SERIES CASE SOT-89-3L

IMPORTANT NOTES AND DISCLAIMER

- ROHS COMPLIANCE: The levels of RoHS restricted materials in this product are below the maximum
 concentration values (also referred to as the threshold limits) permitted for such substances, or are used in an
 exempted application, in accordance with EU RoHS Directive (EU) 2015/863 EC (RoHS3). RoHS Test Report for
 this product can be obtained can be obtained at Download Center.
- REACH COMPLIANCE: REACH substances of high concern (SVHCs) information is available for this product.
 Since the European Chemical Agency (ECHA) has published notice of their intent to frequently revise the SVHC listing for the foreseeable future, REACH Test Report for this product can be obtained can be obtained at Download Center.
- All Product parametric performance is indicated in the Electrical Characteristics for the listed herein test
 conditions, unless otherwise noted. Product performance may not be indicated by the Electrical
 Characteristics if operated under different conditions.
- 4. NextGen Component, Inc (*NextGen*) reserves the right to make changes to this document and its products and specifications at any time without notice. Customers should obtain and confirm the latest product information and specifications before final design, purchase or use.
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- NextGen products are not authorized for use as critical components in life support devices or systems without
 express written approval by NextGen.
- 8. NextGen requires that customers first obtain an RMA (Returned Merchandise Authorization) number prior to returning any products. Returns must be made within 30 days of the date of invoice, be in the original packaging, unused and like-new condition. At the time of quoting or purchasing, a product may say that it is

Non-Cancelable/ Non-Returnable (NCNR). These products are not returnable and not refundable. 6/10/2024